

L Number	Hits	Search Text	DB	Time stamp
1	63348	((tape adj1 chip) tab loc) and ((ground grounding) power)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/12/27 09:03
2	1585	((tape adj1 chip) tab loc) and (((ground grounding) power) near1 lead)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/12/27 09:06
3	1004	((tape adj1 chip) tab loc) and (((ground grounding) power) near1 lead)) and opening	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/12/27 09:17
4	47	((tape adj1 chip) tab loc) and (((ground grounding) power) near1 lead)) and opening) and ((tape film) near3 opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/12/27 09:17
5	159	((tape adj1 chip) tab loc) and (((ground grounding) power) near1 lead)) and opening) and ((tape tab film) near3 opening)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/12/27 09:18
6	97	((tape adj1 chip) tab loc) and (((ground grounding) power) near1 lead)) and opening) and ((tape tab film) near3 opening)) and (semiconductor die chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/12/27 09:18